



PATENT
ATTY. REF. NO. P0889D

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Brian Labrec

Application No.: 10/677,092

Filed: September 30, 2003

For: INCREASING THERMAL CONDUCTIVITY
OF HOST POLYMER USED WITH LASER
ENGRAVING METHODS AND
COMPOSITIONS

Examiner: S. McClendon

Date: April 17, 2008

Art Unit 1796

Confirmation No. 4087

CERTIFICATE OF MAILING

I hereby certify that this paper and the documents referred to as being attached or enclosed herewith are being deposited with the United States Postal Service on April 17, 2008 as First Class Mail in an envelope addressed to: MAIL STOP RCE, COMMISSIONER FOR PATENTS, P.O. Box 1450, Alexandria, VA 22313-1450.

Joel R. Meyer
Attorney for Applicant

INFORMATION DISCLOSURE STATEMENT

Applicants submit herewith information of which they are aware, and which they believe may be material to the examination of the application and in respect of which there may be a duty to disclose in accordance with 37 C.F.R. § 1.56. The information is listed on the attached Form PTO-1449.

The submission of information on the attached Form PTO-1449 is not intended as an admission that any such information constitutes prior art against the claims of the application under examination. Applicants do not waive any right to take any appropriate action to antedate or otherwise remove any information from the attached Form PTO-1449.

No fee is required since this document is being submitted after a Request for Continued Examination and prior to an Office Action.

If a fee is required, please charge to Deposit Account No. 50-2535 any fees that may be required for considering this Information Disclosure Statement under 37 C.F.R. § 1.17(p).

Date: April 17, 2008

Respectfully submitted,

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By
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